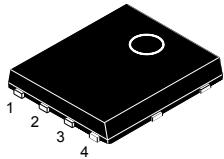


## N-channel 650 V, 0.62 Ω typ., 5 A MDmesh™ M2 Power MOSFET in a PowerFLAT™ 5x6 HV package

### Features


**PowerFLAT 5x6 HV**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	P <sub>TOT</sub>
STL12N65M2	650 V	0.75 Ω	5 A	48 W

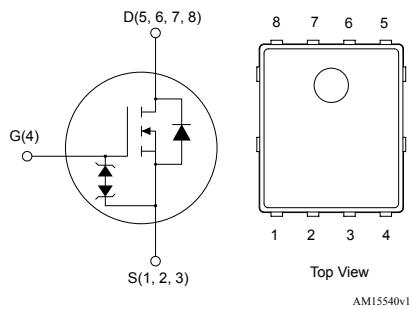
- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications

### Description

This device is an N-channel Power MOSFET developed using MDmesh M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.



#### Product status link

[STL12N65M2](#)

#### Product summary

Order code	STL12N65M2
Marking	12N65M2
Package	PowerFLAT™ 5x6 HV
Packing	Tape and reel

## 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	$\pm 25$	V
$I_D$	Drain current (continuous) at $T_{case} = 25^\circ\text{C}$	5	A
	Drain current (continuous) at $T_{case} = 100^\circ\text{C}$	3.2	
$I_{DM}^{(1)}$	Drain current (pulsed)	20	A
$P_{TOT}$	Total power dissipation at $T_{case} = 25^\circ\text{C}$	48	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	15	V/ns
	MOSFET $dv/dt$ ruggedness	50	
$T_{stg}$	Storage temperature range	-55 to 150	$^\circ\text{C}$
$T_j$	Operating junction temperature range		

1. Pulse width is limited by safe operating area.
2.  $I_{SD} \leq 5 \text{ A}$ ,  $di/dt \leq 400 \text{ A}/\mu\text{s}$ ;  $V_{DS} (\text{peak}) \leq V_{(BR)DSS}$ ,  $V_{DD} = 400 \text{ V}$ .
3.  $V_{DS} \leq 520 \text{ V}$ .

**Table 2. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	2.6	$^\circ\text{C}/\text{W}$
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	50	

1. When mounted on a 1-inch<sup>2</sup> FR-4, 2 Oz copper board.

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}^{(1)}$	Avalanche current, repetitive or not repetitive	1.2	A
$E_{AS}^{(2)}$	Single pulse avalanche energy	105	mJ

1. Pulse width limited by  $T_{jmax}$ .
2. starting  $T_j = 25^\circ\text{C}$ ,  $I_D = I_{AR}$ ,  $V_{DD} = 50 \text{ V}$ .

## 2 Electrical characteristics

( $T_{case} = 25^\circ C$  unless otherwise specified)

**Table 4. Static**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	650			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 650 V$			1	$\mu A$
		$V_{GS} = 0 V, V_{DS} = 650 V, T_{case} = 125^\circ C$ <sup>(1)</sup>			100	
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = 25 V$			$\pm 10$	$\mu A$
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	3	4	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10 V, I_D = 3 A$		0.62	0.75	$\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0 V$	-	410	-	pF
$C_{oss}$	Output capacitance		-	20	-	
$C_{rss}$	Reverse transfer capacitance		-	0.9	-	
$C_{oss eq.}$ <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to $520 V, V_{GS} = 0 V$	-	43	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 MHz$ open drain	-	6.4	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520 V, I_D = 7 A, V_{GS} = 0$ to $10 V$ (see Figure 14)	-	12.5	-	nC
$Q_{gs}$	Gate-source charge		-	3.2	-	
$Q_{gd}$	Gate-drain charge		-	5.8	-	

1.  $C_{oss eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 325 V, I_D = 3.5 A, R_G = 4.7 \Omega, V_{GS} = 10 V$ (see Figure 13 and Figure 18)	-	9.5	-	ns
$t_r$	Rise time		-	7.5	-	
$t_{d(off)}$	Turn-off delay time		-	26	-	
$t_f$	Fall time		-	15	-	

**Table 7. Source-drain diode**

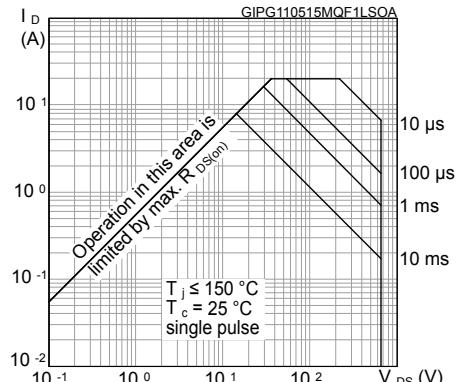
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		5	A
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		20	A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 5 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time		-	318		ns
Q <sub>rr</sub>	Reverse recovery charge	I <sub>SD</sub> = 7 A, di/dt = 100 A/μs, V <sub>DD</sub> = 60 V (see <a href="#">Figure 15</a> )	-	2.5		μC
I <sub>RRM</sub>	Reverse recovery current		-	15.5		A
t <sub>rr</sub>	Reverse recovery time		-	437		ns
Q <sub>rr</sub>	Reverse recovery charge	I <sub>SD</sub> = 7 A, di/dt = 100 A/μs, V <sub>DD</sub> = 60 V, T <sub>j</sub> = 150 °C (see <a href="#">Figure 15</a> )	-	3.2		μC
I <sub>RRM</sub>	Reverse recovery current		-	15		A

1. Pulse width is limited by safe operating area.

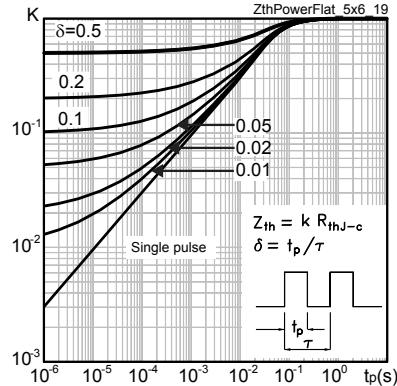
2. Pulse test: pulse duration = 300 μs, duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

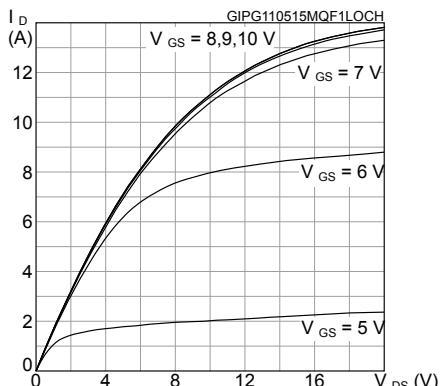
**Figure 1. Safe operating area**



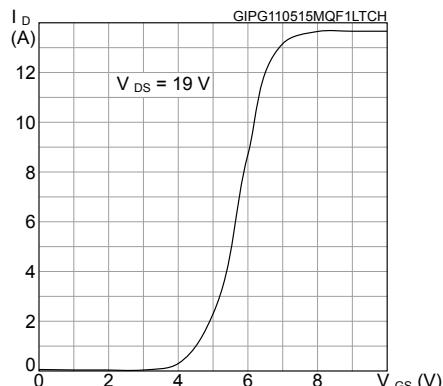
**Figure 2. Thermal impedance**



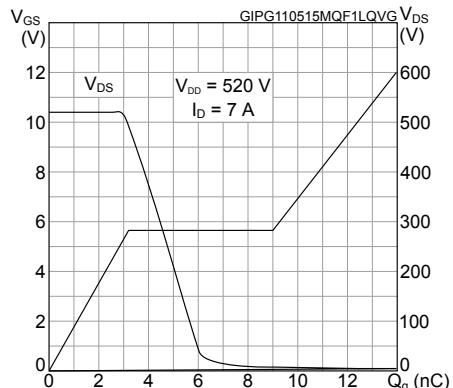
**Figure 3. Output characteristics**



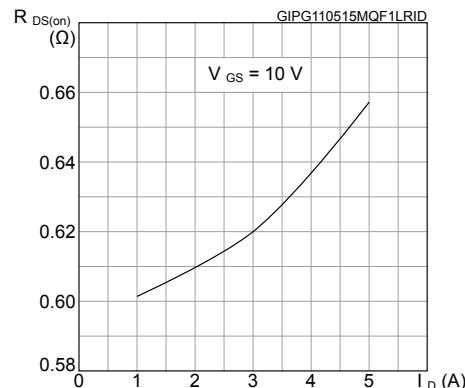
**Figure 4. Transfer characteristics**

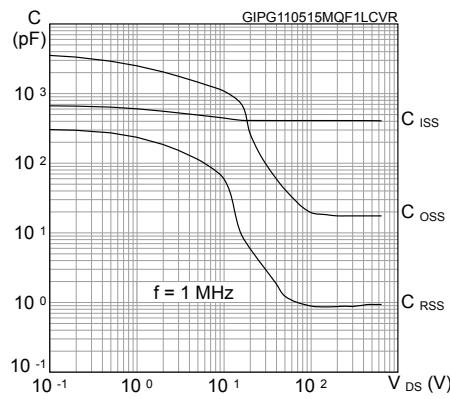
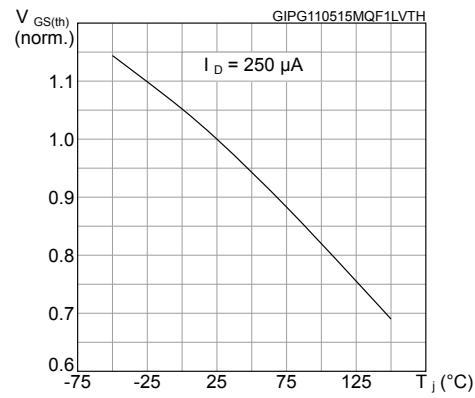
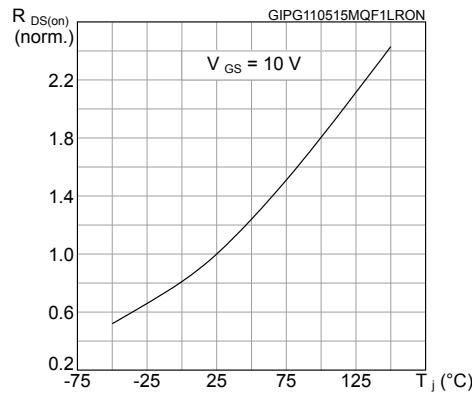
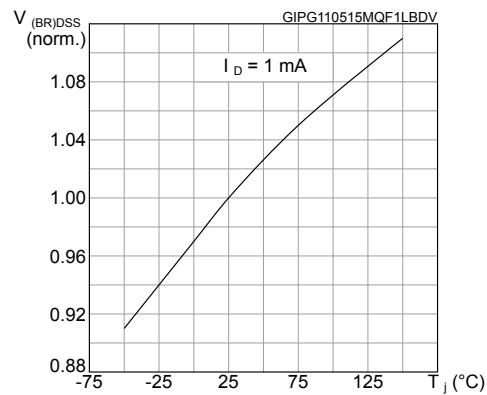
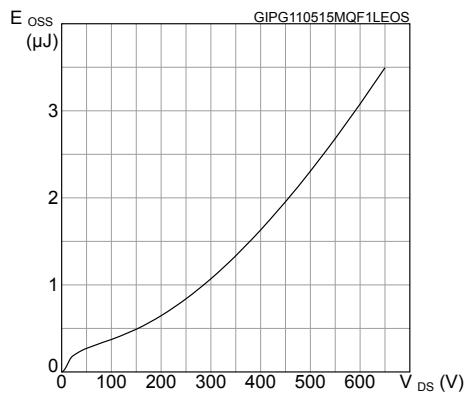
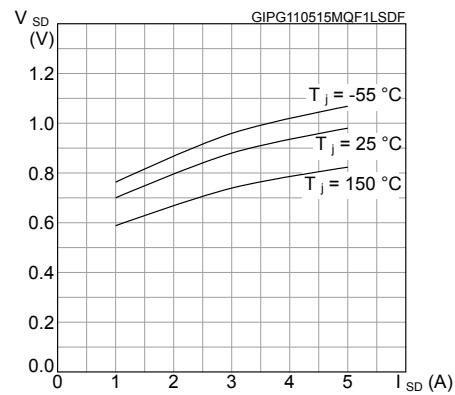


**Figure 5. Gate charge vs gate-source voltage**



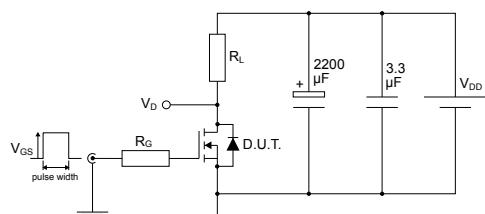
**Figure 6. Static drain-source on-resistance**



**Figure 7. Capacitance variations**

**Figure 8. Normalized gate threshold voltage vs temperature**

**Figure 9. Normalized on-resistance vs temperature**

**Figure 10. Normalized V\_(BR)DSS vs temperature**

**Figure 11. Output capacitance stored energy**

**Figure 12. Source- drain diode forward characteristics**


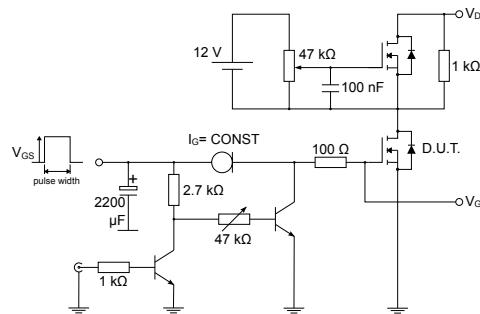
### 3 Test circuits

**Figure 13.** Test circuit for resistive load switching times



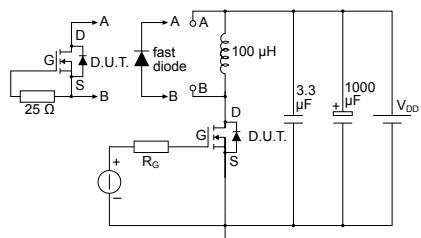
AM01468v1

**Figure 14.** Test circuit for gate charge behavior



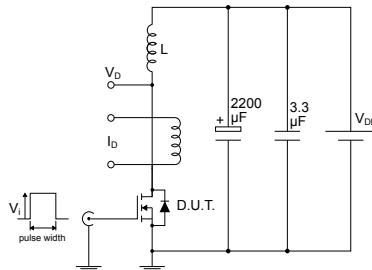
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**Figure 15.** Test circuit for inductive load switching and diode recovery times



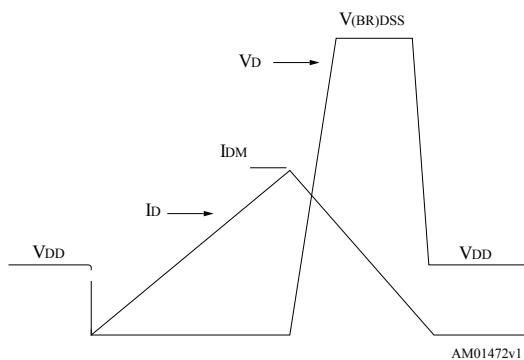
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**Figure 16.** Unclamped inductive load test circuit



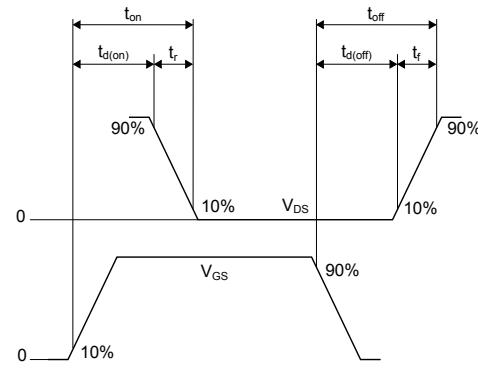
AM01471v1

**Figure 17.** Unclamped inductive waveform



AM01472v1

**Figure 18.** Switching time waveform



AM01473v1

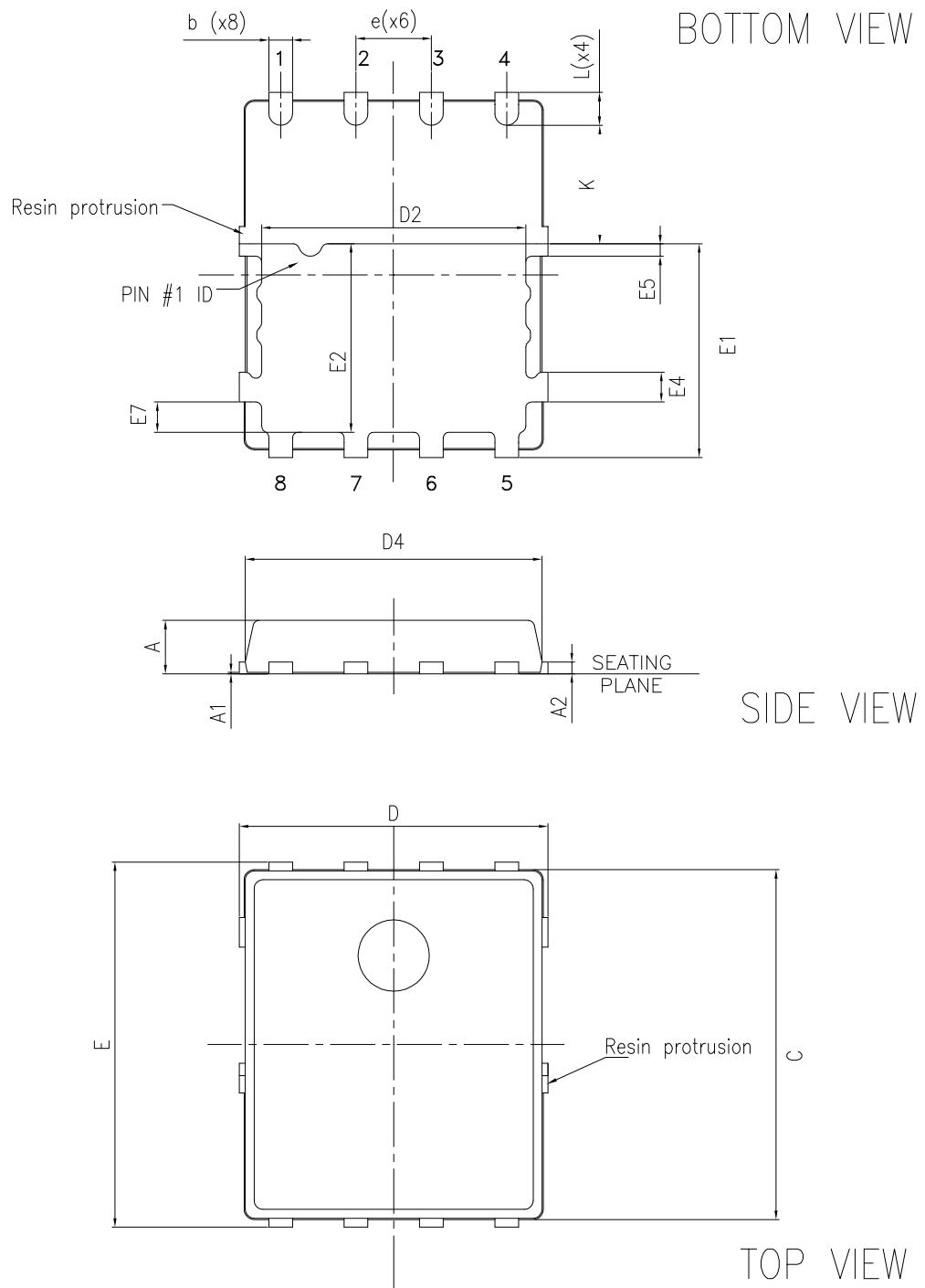
## 4

## Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

## 4.1 PowerFLAT 5x6 HV package information

Figure 19. PowerFLAT 5x6 HV package outline

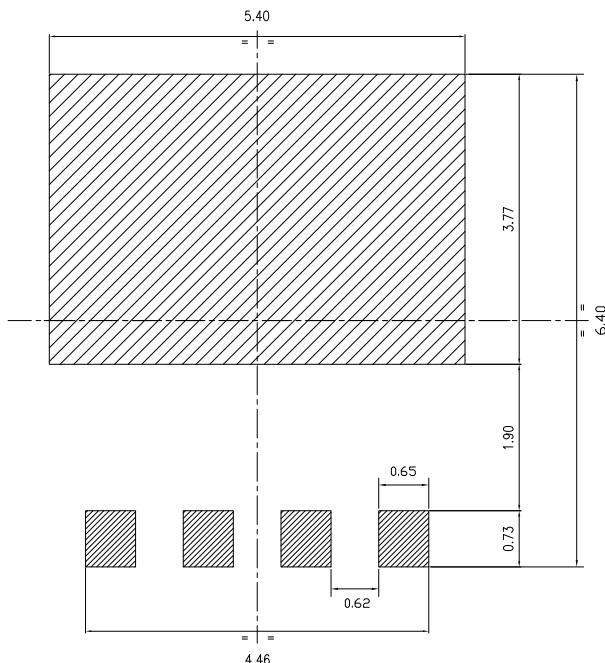


8368143\_Rev\_4

Table 8. PowerFLAT 5x6 HV mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.60	5.80	6.00
D	5.10	5.20	5.30
D2	4.30	4.40	4.50
D4	4.60	4.80	5.00
E	6.05	6.15	6.25
E1	3.50	3.60	3.70
E2	3.10	3.20	3.30
E4	0.40	0.50	0.60
E5	0.10	0.20	0.30
E7	0.40	0.50	0.60
e		1.27	
L	0.50	0.55	0.60
K	1.90	2.00	2.10

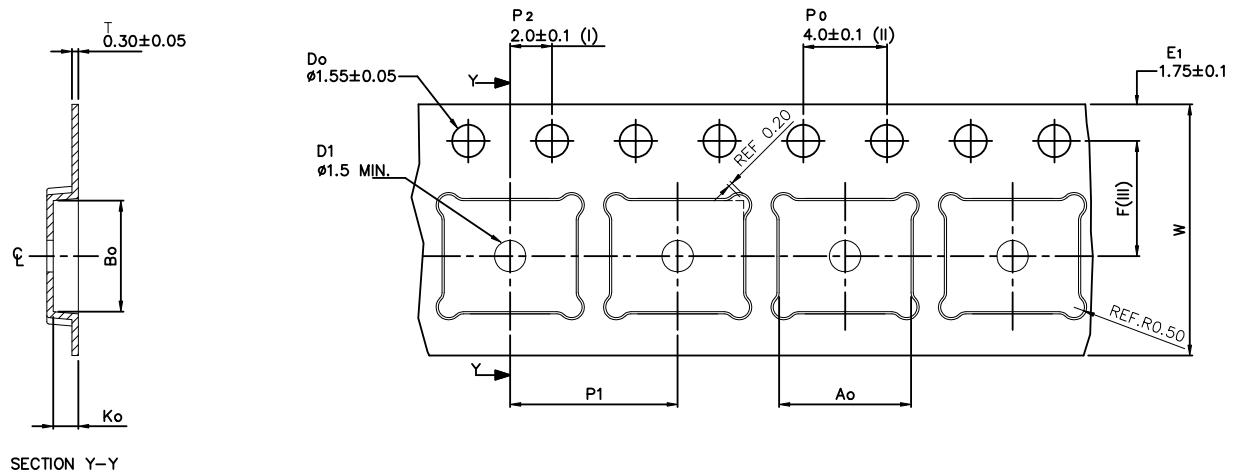
Figure 20. PowerFLAT™ 5x6 HV recommended footprint (dimensions are in mm)



8368143\_Rev\_4\_footprint

## 4.2 PowerFLAT 5x6 packing information

**Figure 21. PowerFLAT 5x6 tape (dimensions are in mm)**



$A_o$	$6.30 \pm 0.1$
$B_o$	$5.30 \pm 0.1$
$K_o$	$1.20 \pm 0.1$
$F$	$5.50 \pm 0.1$
$P_1$	$8.00 \pm 0.1$
$W$	$12.00 \pm 0.3$

(I) Measured from centreline of sprocket hole to centreline of pocket.

Base and bulk quantity 3000 pcs  
All dimensions are in millimeters

(II) Cumulative tolerance of 10 sprocket holes is  $\pm 0.20$ .

(III) Measured from centreline of sprocket hole to centreline of pocket

8234350\_Tape\_rev\_C

**Figure 22. PowerFLAT 5x6 package orientation in carrier tape**

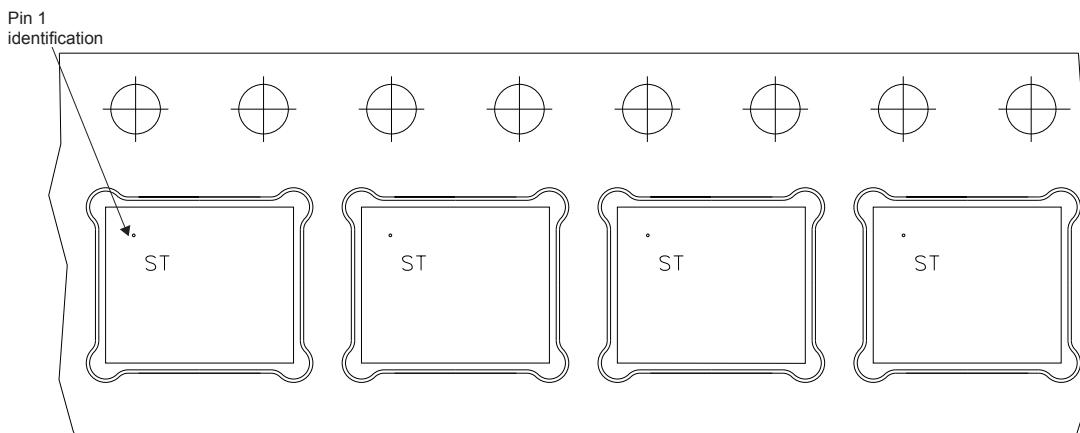
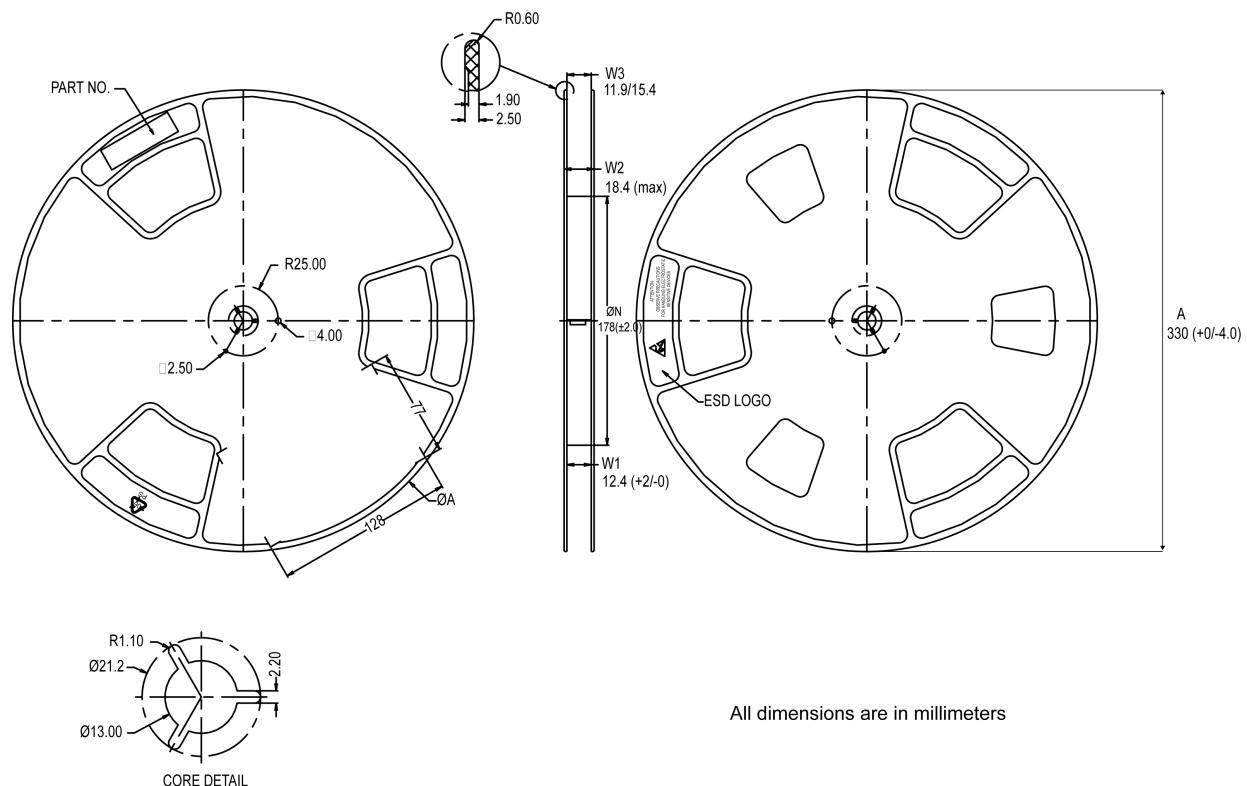


Figure 23. PowerFLAT 5x6 reel



All dimensions are in millimeters

8234350\_Reel\_rev\_C

## Revision history

**Table 9. Document revision history**

Date	Revision	Changes
11-May-2015	1	First release.
20-Jun-2019	2	Updated <a href="#">Section 1</a> and <a href="#">Section 2</a>

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